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Bioinspired reversible hydrogel adhesives for wet and underwater surfaces†

Hoon Yi,^a Sung Ho Lee,^b Minho Seong,^a Moon Kyu Kwak ^b and Hoon Eui Jeong *^a

Stable and reversible adhesion to wet surfaces is challenging owing to water molecules at the contact interface. In this study, we develop a hydrogel-based wet adhesive, which can exhibit strong and reversible adhesion to wet and underwater surfaces as well as to dry surfaces. The remarkable wet adhesion of the hydrogel adhesive is realized based on a synergetic integration of bioinspired microarchitectures and water-friendly and water-absorbing properties of the polymeric hydrogel. Under dry conditions, the microstructured hydrogel adhesive exhibits strong van der Waals interaction-based adhesion, while under underwater conditions, it can maximize capillary adhesion. Consequently, the hydrogel adhesive exhibits remarkable adhesion strengths for dry, moist, and submerged substrates. Maximum normal and shear adhesion strengths of 423 and 384, 492 and 340, and 253 and 21 kPa are achieved with the hydrogel adhesive for dry, moist, and submerged substrates, respectively. Our results demonstrate that strong wet and underwater adhesion can be achieved only with the hydrogel-based adhesive with simple microscale architecture.

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Introduction

Robust adhesion to wet surfaces is of significance in diverse applications such as medical operations, marine structures, energy devices operating under wet environments (*e.g.*, fuel cells), transfer printing, and even daily goods.^{1–8} Stable adhesion between surfaces can be obtained by keeping the distance between the surfaces very close to the atomic level. In typical dry environments, such tight contact between surfaces can be easily achieved by utilizing materials with low effective elastic moduli so that they can follow the roughness of the target surface.^{9–17} However, in wet environments, water molecules not only penetrate gaps between the surfaces easily, but also reduce the adhesion strengths of the adhesive materials by hydrating and decomposing them. Consequently, it is very challenging to ensure good adhesion under wet conditions.^{1,3,8,18–20} Although cyanoacrylate (Super GlueTM) is a strong tissue adhesive, it is cytotoxic, and incompatible with wet or underwater surfaces because the uncured adhesive rapidly solidifies into a glassy phase when it comes into contact with water.^{21,22} In order to overcome such difficulties, synthetic wet adhesives emulating

natural adhesive materials of marine organisms have been extensively investigated.²³ Representative examples include wet adhesives mimicking the proteins present in biological system such as mussel adhesives,^{23–26} barnacle cements,²⁷ and sandcastle-worm glues.²⁸ These marine organism-inspired synthetic wet adhesives typically have the use of 3,4-dihydroxyphenylalanine (DOPA) in common, and many different types of DOPA-based wet adhesives have demonstrated effective wet adhesion performance.^{1,5,7,29} However, they also pose several limitations such as adhesion degradation by wet-air oxidation, long contact-forming time, and high production cost. In addition, they are not suitable for applications that require reversible and reusable wet adhesion, as they are typically permanent adhesives that lack reversible adhesion capability.^{1,30}

Bioinspired dry adhesives based on micro- or nanostructure arrays that emulate biological fibrillar adhesives have emerged as reversible and reusable adhesives for various dry surfaces. Their reversible dry adhesion could be realized by maximizing van der Waals interactions with the target surface with the aid of the micro- or nanostructure array.^{31–41} Most of the existing bioinspired dry adhesives are composed of elastomers with hydrophobic surface properties (*e.g.*, polydimethylsiloxane (PDMS)).^{42–49} This indicates that they have potential as wet or underwater adhesives because hydrophobic elastomers promote removal of the water at the contact interface and therefore initiate interfacial adhesion in wet environments.^{50,51} In reality, however, water entrapment often occurs at the contact interface even when using a hydrophobic elastomer because it is difficult

^a Department of Mechanical Engineering, Ulsan National Institute of Science and Technology, Ulsan 689-798, Republic of Korea. E-mail: hoonejeong@unist.ac.kr

^b Department of Mechanical Engineering, Kyungpook National University, Daegu 702-701, Republic of Korea

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In this study, we develop a bioinspired wet adhesive utilizing a hydrogel, which can exhibit immediate, strong and reversible adhesion under wet and underwater conditions based on the water-absorbing properties and capillary adhesion of the microstructured hydrogel. The hydrogel adhesive consists of a bioinspired micropillar array made of the biocompatible polyethylene glycol (PEG) hydrogel, which can absorb a large quantity of water and is hydrophilic. In this PEG-based bioinspired adhesive, the biomimetic microarchitecture enables conformal physical contact to target surfaces, while the PEG polymer absorbs water at the contact interface and enables capillary adhesion. Consequently, robust and reversible wet adhesion can be achieved under wet and underwater conditions only with the hydrogel adhesive, without the need for complex surface modification with chemical moieties. The wet adhesion behavior of the bioinspired hydrogel adhesive well agrees with theoretical models.

Fabrication of the hydrogel adhesive

SU-8 was then spin-coated onto the LOR layer and baked at 100 °C for 5 min. Subsequently, the SU-8/LOR bilayer on the wafer was exposed to ultraviolet (UV) light ($\lambda = 365$ nm, dose = 250 mJ cm⁻²), followed by post-exposure baking (100 °C for 3 min). Microhole array patterns were then generated in the SU-8 layer by development using a SU-8 developer. Subsequently, selective removal of the LOR layer was carried out to form an undercut in the LOR layer using a LOR developer (AZ 400K, AZ Electronics Materials Corporation). In order to generate a PEG dimethacrylate (PEGDMA) adhesive, a drop of an 80 wt% PEGDMA solution (molecular weight: 750, Sigma Aldrich) mixed with 20 wt% of deionized (DI) water and 0.2 wt% of an Irgacure 2959 photoinitiator (Sigma Aldrich) was uniformly dispensed onto the patterned master.^{58–61} Subsequent photopolymerization of the PEGDMA solution by UV irradiation ($\lambda = 365$ nm, dose = 300 mJ cm⁻²) and removal of the cured PEGDMA from the master yielded the PEGDMA adhesive with a bioinspired microstructure array.^{62,63}

Scanning electron microscopy (SEM) images of the fabricated PEGDMA sample were acquired using a HITACHI S-4800 microscope (Hitachi, Japan). To image the swollen PEGDMA microstructures, the PEGDMA sample was first submerged in DI water for 12 h. Next, the swollen PEGDMA sample was lyophilized. In order to avoid charging effects, the PEGDMA sample was coated with a 5 nm-thick Pt layer using a sputter coater (K575X, Quorum Emitech, UK). The water contact angles (CAs) on the planar PEGDMA and glass substrates were measured using a drop shape analyzer (SDLAB 200TEZD, FEMTOFAB, Korea) at room temperature (25 °C). The measurements for each sample were performed five times and the average values were used.

The normal and shear adhesion of the adhesive samples were measured with custom-built equipment. The equipment consisted of motorized movable parts along the vertical and horizontal directions, load cells connected to the movable parts, and the sample holder. Adhesive samples with sizes of $1 \pm 0.01 \text{ cm}^2$ were attached to dry, moist, and submerged substrates (glass, Au, and porcine skin) with controlled preloads in the range of 20–300 kPa. After the application of the preload, the motorized part was moved along the vertical (normal adhesion test) or horizontal (shear adhesion test) axis with a retraction rate of 0.5 mm s^{-1} until the occurrence of separation at the adhesive/substrate interface. For the adhesion measurements against the moist substrate, a 3 μL water droplet was uniformly dispensed on the substrate to an area of $1 \times 1 \text{ cm}^2$. Subsequently, preloads were applied to the samples for a few seconds before the measurement. For the underwater adhesion measurements, the substrates were affixed to a mount in a small water bath placed on the adhesion test equipment. The adhesive samples were then submerged in the water bath for 10 min, followed by the pull-off and shear strength measurements. For each experimental condition, two specimens

Results and discussion

Fabrication and structure of the hydrogel adhesive

Fig. 1a shows a schematic of the hydrogel adhesive fabrication. As described above, the hydrogel adhesive was prepared using a replica molding technique against a patterned master using PEGDMA as a base material. PEGDMA is a hydrophilic polymeric hydrogel, which can absorb a large quantity of water. It can be rapidly cured by UV light irradiation within a few tens of seconds, which enables precise and scalable fabrication of diverse micro/nanostructures. In addition, its mechanical properties can be easily modulated by adjusting its concentration in water. Furthermore, it is biocompatible and thus can be utilized for various biomedical applications.^{3,19} Fig. 1b shows the fabricated PEGDMA hydrogel adhesive. The resulting PEGDMA adhesive is in the form of a highly flexible film on which a uniform microstructure array is regularly formed (Fig. 1b-i). The individual microstructures have protruding heads on cylindrical stems (Fig. 1b-ii and iii). The protruding heads of the microstructures are beneficial to obtain high adhesion strengths against various surfaces based on van der Waals interactions without any surface treatment with adhesive chemical moieties. According to previous studies, the adhesion strengths of the microstructures with protruding heads are 5–26 times higher than those of simple microstructures with flat or hemispherical ends.³⁴ The fabricated microstructures had a tip diameter of 24 μm , stem diameter of 20 μm , height of 25 μm , and spacing of 20 μm . It is worth noting that the fabricated PEGDMA in this study does not have a supporting layer (e.g., polyethylene terephthalate), as it leads to macroscopic bending of the adhesive film in the presence of water due to a mismatch in volume expansion between the swollen PEGDMA layer and nonswellable supporting layer.¹⁹

Wet adhesion behavior of the hydrogel adhesive

In order to evaluate the adhesion properties of the PEGDMA adhesive, we quantitatively measured the pull-off and shear strengths of the adhesive against a flat glass substrate under dry, wet, and underwater conditions (Fig. 2a). Under the wet conditions, the adhesion measurements were performed against a glass surface moistened with water. Under the underwater conditions, the adhesion measurements were performed against a submerged substrate. Adhesion of a polydimethylsiloxane (PDMS) adhesive was also evaluated for comparison. Fig. 2b-i and ii show the measured pull-off and shear strengths of the PDMS and PEGDMA adhesives with a preload of 20 kPa for the three different conditions. Overall, under the dry conditions, the PDMS and PEGDMA adhesives exhibited similar adhesion at a preload of 20 kPa. The normal adhesion strengths of the PDMS and PEGDMA adhesives were 152.3 and 160.6 kPa, respectively (Fig. 2c-i). The shear strengths of the PDMS and PEGDMA adhesives were 143.8 and 153.2 kPa, respectively (Fig. 2c-ii). However, for the moist substrate, the PDMS and PEGDMA adhesives exhibited completely different adhesion behaviors. The pull-off (normal) and shear strengths of the PDMS adhesive were significantly reduced to 40.2 and 24.2 kPa, respectively, which are 26.4% and 16.8%, respectively, of those against the dry substrate. This indicates that the PDMS adhesive has limited utility as a wet adhesive. On the contrary, the pull-off strength of the PEGDMA adhesive maintained a rather high value (143.4 kPa) against the wet substrate (Fig. 2c-i),

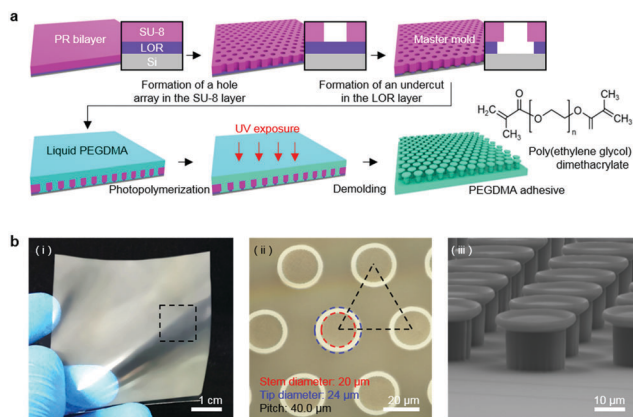


Fig. 1 (a) Schematic of the fabrication procedure of the PEGDMA adhesive. (b) (i) Photograph, (ii) microscopy image, and (iii) SEM image of the fabricated PEGDMA adhesive.

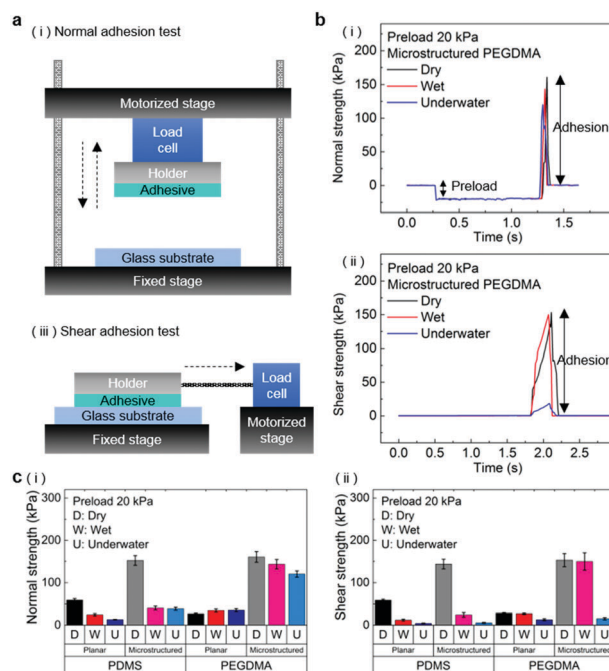


Fig. 2 (a) Experimental setups for (i) normal and (ii) shear adhesion measurements. (b) Representative examples of the measured (i) normal and (ii) shear adhesion under the three different conditions at a preload of 20 kPa. (c) (i) Normal and (ii) shear adhesion strengths of the PEGDMA and PDMS adhesives under the three different conditions at a preload of 20 kPa. Error bars represent standard deviations ($N = 20$).

which is equal to 89.3% of that for the dry substrate. In addition to the normal adhesion, the shear strength of the PEGDMA adhesive also remained at a high level (150 kPa) (Fig. 2c-ii), which is 97.9% of that for the dry substrate. The PEGDMA adhesive exhibited significant adhesion even to the submerged substrate (Fig. 2b and c). For the submerged substrate, the PEGDMA adhesive exhibited a normal adhesion strength of 120.2 kPa, whereas the PDMS adhesive exhibited a significantly degraded normal adhesion strength of 38.5 kPa. The shear adhesion of the PEGDMA adhesive decreased to 15.4 kPa for the submerged surface. However, this value is 2.75 times higher than that of the PDMS adhesive (5.6 kPa).

In order to further evaluate the wet adhesion performance of the PEGDMA adhesive, its normal and shear adhesion strengths were investigated at different preloads in the range of 20–300 kPa (Fig. 3). Under dry conditions (Fig. 4a-i), the maximum normal and shear adhesion strengths of the PEGDMA adhesive were 422.9 and 384.2 kPa at a preload of 300 kPa, respectively (Fig. 3a and b). In contrast, the maximum normal and shear adhesion strengths of the PDMS adhesive were 185.6 kPa (at a preload of 100 kPa) and 170.5 kPa (at a preload

of 50 kPa), respectively. Theoretically, the normal and shear adhesion forces of microstructures with protruding tips are:^{64,65}

$$P_{\text{normal}} = A \sqrt{\frac{\pi W_{12} E}{2a(1-\nu^2)}} \quad (1a)$$

$$P_{\text{shear}} = \mu A \sqrt{\frac{\pi W_{12} E}{2a(1-\nu^2)}} \quad (1b)$$

where A is the contact area, W_{12} is the work of adhesion between the contacting surfaces, E is the elastic modulus of the material used for the microstructures, ν is the Poisson's ratio of the material, a is the radius of the detached zone of the microstructures with protruding tips, and μ is the friction coefficient. The higher surface energy (42.5 mJ m⁻²) and elastic modulus (15.5 MPa) of PEGDMA than those of PDMS (surface energy: 20.5 mJ m⁻², elastic modulus: 1–2 MPa) lead to higher adhesion to the dry surface.^{19,43,66,67} Our experimental adhesion-test results for the dry substrate are in agreement with the theoretical predictions ($\mu \approx 1.0$, as shown in Fig. 4e; see Fig. S1 (ESI†) for the determination of the friction coefficient). It is worth noting that the relatively higher adhesion of the PEGDMA adhesive compared with that of the PDMS adhesive could be attributed to the hydrogen bonds between the PEG hydrogel and glass substrate.⁶⁸ To test this hypothesis, we performed additional adhesion measurements against Au and skin substrates (Fig. 3c and Fig. S3, ESI†). According to the measurement results, the PEGDMA adhesives exhibit overall similar adhesion strengths on the Au substrate compared to those on the glass substrate. It is observed that the adhesion strength of the planar PDMS on the glass was higher than that of the planar PEGDMA sample on the glass (Fig. 2c). These results indicate that the hydrogen bonds between the PEGDMA adhesive and glass do not play a critical role in the measured macroscopic adhesion of the microstructured PEGDMA adhesive. The adhesion strengths of the PEGDMA adhesive on skin were much lower than those on the glass or Au substrates due to the relatively high surface roughness of skin compared with that of the flat glass or Au substrates.

For a moist substrate, the PEGDMA adhesive exhibited maximum normal and shear strengths of 491.8 and 340 kPa at a preload of 300 kPa, respectively, which are similar to those of the PEGDMA adhesive for the dry substrate (Fig. 3a and b). On the contrary, for the moist substrate, the maximum normal and shear strengths of the PDMS adhesive were significantly reduced to 48.3 and 31.5 kPa (at a preload of 100 kPa), respectively (Fig. 3a and b). The remarkable adhesion strengths of the PEGDMA adhesive for the moist substrate mainly originated from the swelling behavior of the PEGDMA hydrogel, which can absorb a large amount of water. When the microstructured PEGDMA adhesive contacts the water on the substrate, the water is entrapped in the three-dimensional polymeric network of the PEGDMA microstructures (Fig. 4b), leading to partial or complete removal of the water on the substrate (Fig. 4a-ii). Accordingly, the PEGDMA adhesive can be in closer contact with the substrate. Furthermore, the diameter of the hydrogel



Fig. 3 (a) Normal and (b) shear adhesion strengths of the (i) microstructured and (ii) planar adhesives under the different conditions as a function of the preload. (c) Normal adhesion strengths of the microstructured PEGDMA adhesives on different substrates, namely glass, Au, and porcine skin. (d) Repeatability test results showing the normal adhesion strength of the PEGDMA adhesive under underwater conditions (preload: 20 kPa). Error bars represent standard deviations (for (a)–(c); $N = 20$).

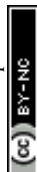




Fig. 4 (a) Conceptual illustrations showing the PEGDMA adhesive in contact with (i) dry, (ii) moist, and (iii) submerged substrates. (b) Conceptual illustration of the reversible swelling behavior of the PEGDMA hydrogel. (c) Diameter of the PEGDMA microstructures as a function of the water exposure time. (d) Water CA on the planar PEGDMA surface as a function of the time. Comparisons of the measured (i) normal and (ii) shear adhesion with the theoretical predictions for the (e) dry, (f) wet, and (g) underwater conditions. Error bars represent standard deviations (for (e)–(g); $N = 20$).

microstructures increased owing to the swelling of the hydrogel (Fig. 4c). Consequently, a high level of adhesion can be obtained with the PEG-hydrogel-based adhesive for the moist substrate. The maximum experimental adhesion values for this case followed eqn (1) well (Fig. 4f). On the contrary, in the case of the PDMS adhesive, the water on the substrate could not be perfectly removed despite the hydrophobic nature of PDMS. Consequently, the water remaining on the substrate hinders close contact between the microstructure and substrate, leading to the remarkably reduced normal and shear adhesion strengths.^{1,6,8,18–20} In this case, the adhesion originated mainly from capillary adhesion. The capillary adhesion between two adjacent surfaces is expressed as:^{69,70}

$$P_{\text{capillary}} = \frac{\gamma \pi r^2}{h} (\cos \theta_1 + \cos \theta_2) \quad (2)$$

where γ is the surface tension of water, r is the contact radius, h is the thickness of the water layer, and θ_1 and θ_2 are the water

CAs at the two surfaces. The adhesion behavior of the PDMS adhesive for the wet surface agrees well with eqn (2) (Fig. 4g).

The PEGDMA adhesive exhibited significant adhesion even to the submerged surface. The maximum normal adhesion of the PEGDMA adhesive reached 253 kPa (at a preload of 300 kPa), whereas that of the PDMS adhesive was 42.2 kPa (at a preload of 100 kPa). The superior underwater adhesion of the PEGDMA adhesive is based on enhanced capillary adhesion owing to the water-friendly characteristic of the PEGDMA hydrogel. According to eqn (2), the capillarity-induced normal adhesion strength is higher for a hydrophilic material with a lower water CA. In the case of PEGDMA, the water CA monotonously decreased with the increase in the water exposure time, reaching 36° at equilibrium (Fig. 4d), while that of PDMS was approximately 120° regardless of the water exposure time. The theoretically calculated adhesion strength of the PEGDMA adhesive is 274.8 kPa for a submerged glass substrate, while that of the PDMS adhesive is 43.7 kPa, which agrees well with our experimental observations (Fig. 4g). The maximum shear adhesion



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